

|                     |       |
|---------------------|-------|
| $V_{DSS}$           | 250V  |
| $R_{DS(on)}$ (Max.) | 235mΩ |
| $I_D$               | 12A   |
| $P_D$               | 40W   |

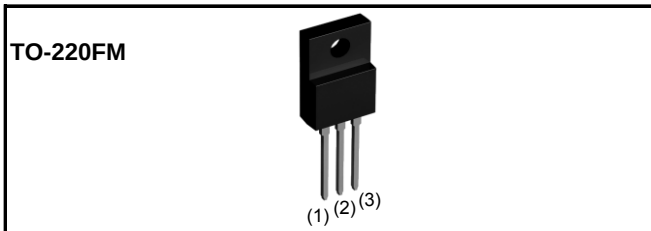
### ●Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Drive circuits can be simple.
- 4) Parallel use is easy.
- 5) Pb-free lead plating ; RoHS compliant
- 6) 100% Avalanche tested

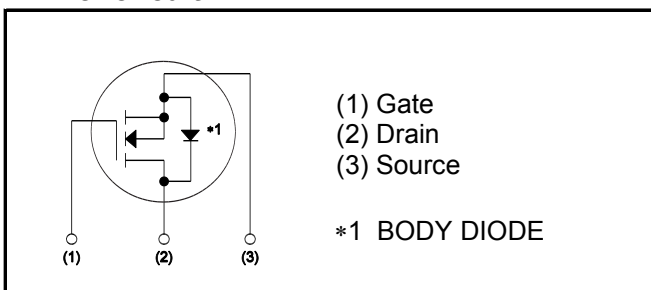
### ●Application

Switching Power Supply  
Automotive Motor Drive  
Automotive Solenoid Drive

### ●Outline



### ●Inner circuit



### ●Packaging specifications

|      |                           |           |
|------|---------------------------|-----------|
| Type | Packaging                 | Bulk      |
|      | Reel size (mm)            | -         |
|      | Tape width (mm)           | -         |
|      | Basic ordering unit (pcs) | 500       |
|      | Taping code               | -         |
|      | Marking                   | RCX120N25 |

### ●Absolute maximum ratings ( $T_a = 25^\circ\text{C}$ )

| Parameter                      |                           | Symbol             | Value       | Unit |
|--------------------------------|---------------------------|--------------------|-------------|------|
| Drain - Source voltage         |                           | $V_{DSS}$          | 250         | V    |
| Continuous drain current       | $T_c = 25^\circ\text{C}$  | $I_D^{*1}$         | ±12         | A    |
|                                | $T_c = 100^\circ\text{C}$ | $I_D^{*1}$         | ±6.5        | A    |
| Pulsed drain current           |                           | $I_{D,pulse}^{*2}$ | ±48         | A    |
| Gate - Source voltage          |                           | $V_{GSS}$          | ±30         | V    |
| Avalanche energy, single pulse |                           | $E_{AS}^{*3}$      | 10.5        | mJ   |
| Avalanche current              |                           | $I_{AR}^{*3}$      | 6.0         | A    |
| Power dissipation              | $T_c = 25^\circ\text{C}$  | $P_D$              | 40          | W    |
|                                | $T_a = 25^\circ\text{C}$  | $P_D$              | 2.23        | W    |
| Junction temperature           |                           | $T_j$              | 150         | °C   |
| Range of storage temperature   |                           | $T_{stg}$          | -55 to +150 | °C   |

## ●Thermal resistance

| Parameter                                    | Symbol     | Values |      |       | Unit |
|----------------------------------------------|------------|--------|------|-------|------|
|                                              |            | Min.   | Typ. | Max.  |      |
| Thermal resistance, junction - case          | $R_{thJC}$ | -      | -    | 3.125 | °C/W |
| Thermal resistance, junction - ambient       | $R_{thJA}$ | -      | -    | 56    | °C/W |
| Soldering temperature, wavesoldering for 10s | $T_{sold}$ | -      | -    | 265   | °C   |

●Electrical characteristics ( $T_a = 25^\circ\text{C}$ )

| Parameter                                   | Symbol            | Conditions                                                | Values |      |           | Unit          |
|---------------------------------------------|-------------------|-----------------------------------------------------------|--------|------|-----------|---------------|
|                                             |                   |                                                           | Min.   | Typ. | Max.      |               |
| Drain - Source breakdown voltage            | $V_{(BR)DSS}$     | $V_{GS} = 0V, I_D = 1mA$                                  | 250    | -    | -         | V             |
| Zero gate voltage drain current             | $I_{DSS}$         | $V_{DS} = 250V, V_{GS} = 0V$<br>$T_j = 25^\circ\text{C}$  | -      | -    | 10        | $\mu\text{A}$ |
|                                             |                   | $V_{DS} = 250V, V_{GS} = 0V$<br>$T_j = 125^\circ\text{C}$ | -      | -    | 100       |               |
| Gate - Source leakage current               | $I_{GSS}$         | $V_{GS} = \pm 30V, V_{DS} = 0V$                           | -      | -    | $\pm 100$ | nA            |
| Gate threshold voltage                      | $V_{GS(th)}$      | $V_{DS} = 10V, I_D = 1mA$                                 | 3.0    | -    | 5.0       | V             |
| Static drain - source on - state resistance | $R_{DS(on)}^{*4}$ | $V_{GS} = 10V, I_D = 6.0A$                                | -      | 180  | 235       | $m\Omega$     |
|                                             |                   | $V_{GS} = 10V, I_D = 6.0A$<br>$T_j = 125^\circ\text{C}$   | -      | 340  | 480       |               |
| Forward transfer admittance                 | $g_{fs}$          | $V_{DS} = 10V, I_D = 6.0A$                                | 3.25   | 6.50 | -         | S             |

**●Electrical characteristics ( $T_a = 25^\circ\text{C}$ )**

| Parameter                    | Symbol            | Conditions                          | Values |      |      | Unit |
|------------------------------|-------------------|-------------------------------------|--------|------|------|------|
|                              |                   |                                     | Min.   | Typ. | Max. |      |
| Input capacitance            | $C_{iss}$         | $V_{GS} = 0V$                       | -      | 1800 | -    | pF   |
| Output capacitance           | $C_{oss}$         | $V_{DS} = 25V$                      | -      | 100  | -    |      |
| Reverse transfer capacitance | $C_{rss}$         | $f = 1\text{MHz}$                   | -      | 60   | -    |      |
| Turn - on delay time         | $t_{d(on)}^{*4}$  | $V_{DD} \approx 125V, V_{GS} = 10V$ | -      | 33   | -    | ns   |
| Rise time                    | $t_r^{*4}$        | $I_D = 6.0A$                        | -      | 65   | -    |      |
| Turn - off delay time        | $t_{d(off)}^{*4}$ | $R_L = 20.83\Omega$                 | -      | 45   | -    |      |
| Fall time                    | $t_f^{*4}$        | $R_G = 10\Omega$                    | -      | 20   | -    |      |

**●Gate Charge characteristics ( $T_a = 25^\circ\text{C}$ )**

| Parameter            | Symbol          | Conditions                       | Values |      |      | Unit |
|----------------------|-----------------|----------------------------------|--------|------|------|------|
|                      |                 |                                  | Min.   | Typ. | Max. |      |
| Total gate charge    | $Q_g^{*4}$      | $V_{DD} \approx 125V$            | -      | 35   | -    | nC   |
| Gate - Source charge | $Q_{gs}^{*4}$   | $I_D = 12A$                      | -      | 15   | -    |      |
| Gate - Drain charge  | $Q_{gd}^{*4}$   | $V_{GS} = 10V$                   | -      | 12   | -    |      |
| Gate plateau voltage | $V_{(plateau)}$ | $V_{DD} \approx 125V, I_D = 12A$ | -      | 7.6  | -    | V    |

**●Body diode electrical characteristics (Source-Drain)( $T_a = 25^\circ\text{C}$ )**

| Parameter                 | Symbol        | Conditions               | Values |      |      | Unit |
|---------------------------|---------------|--------------------------|--------|------|------|------|
|                           |               |                          | Min.   | Typ. | Max. |      |
| Continuous source current | $I_S^{*1}$    | $T_c = 25^\circ\text{C}$ | -      | -    | 12   | A    |
| Pulsed source current     | $I_{SM}^{*2}$ |                          | -      | -    | 48   | A    |
| Forward voltage           | $V_{SD}^{*4}$ | $V_{GS} = 0V, I_S = 12A$ | -      | -    | 1.5  | V    |
| Reverse recovery time     | $t_{rr}^{*4}$ | $I_S = 6.0A$             | -      | 105  | -    | ns   |
| Reverse recovery charge   | $Q_{rr}^{*4}$ | $di/dt = 100A/\mu s$     | -      | 410  | -    | nC   |

\*1 Limited only by maximum temperature allowed.

\*2  $P_w \leq 10\mu s$ , Duty cycle  $\leq 1\%$

\*3  $L \approx 500\mu H$ ,  $V_{DD} = 50V$ ,  $R_g = 25\Omega$ , starting  $T_j = 25^\circ\text{C}$

\*4 Pulsed

●Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

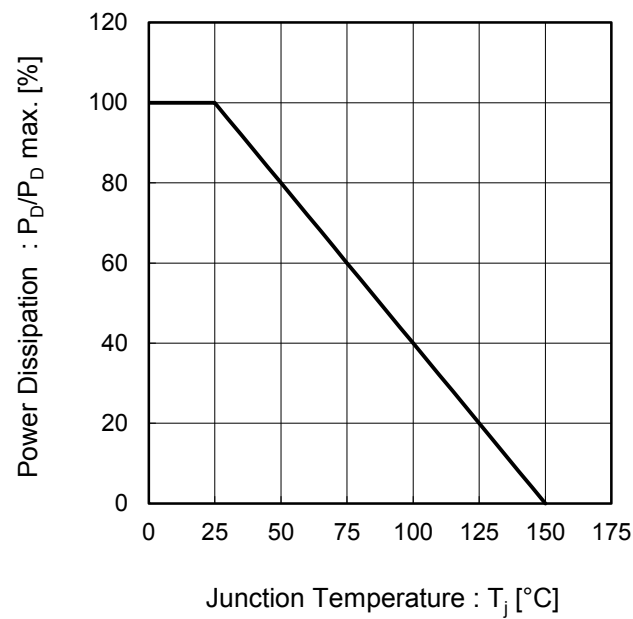


Fig.2 Maximum Safe Operating Area

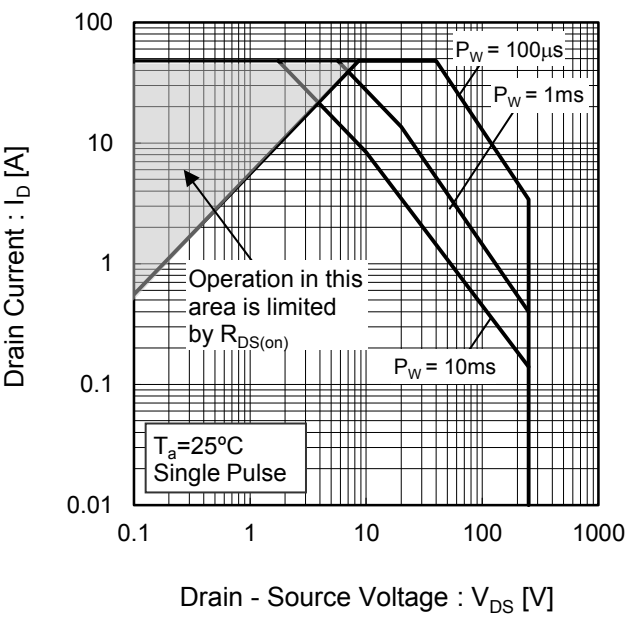
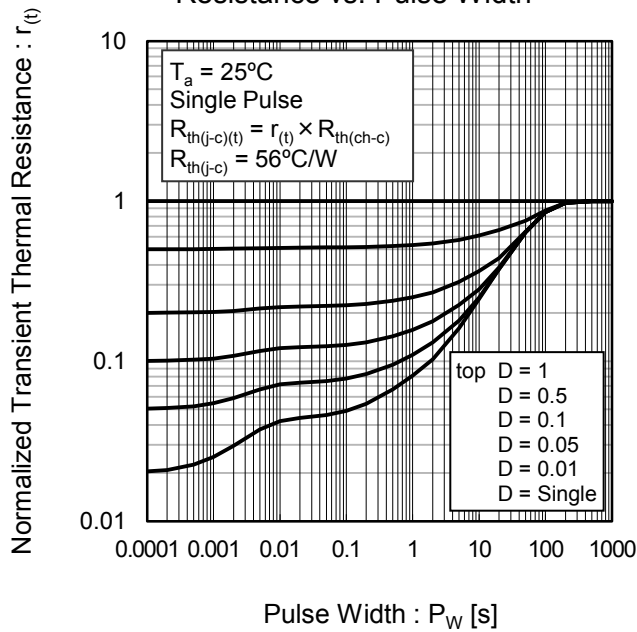


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width



●Electrical characteristic curves

Fig.4 Avalanche Current vs Inductive Load

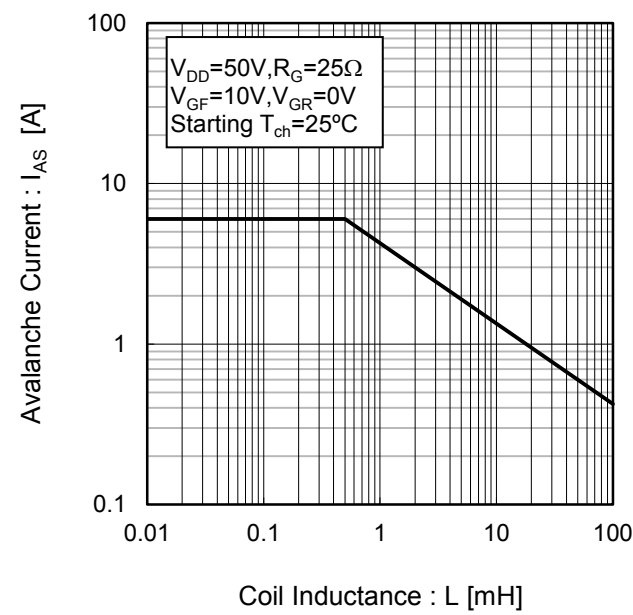


Fig.5 Avalanche Energy Derating Curve vs Junction Temperature

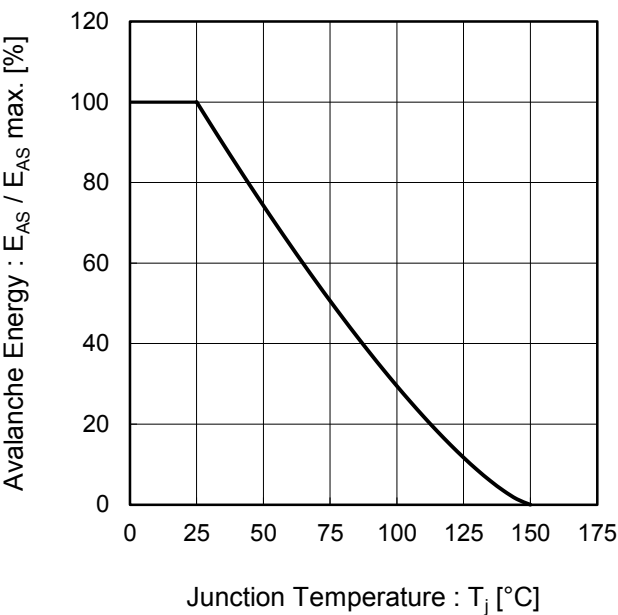


Fig.6 Typical Output Characteristics(I)

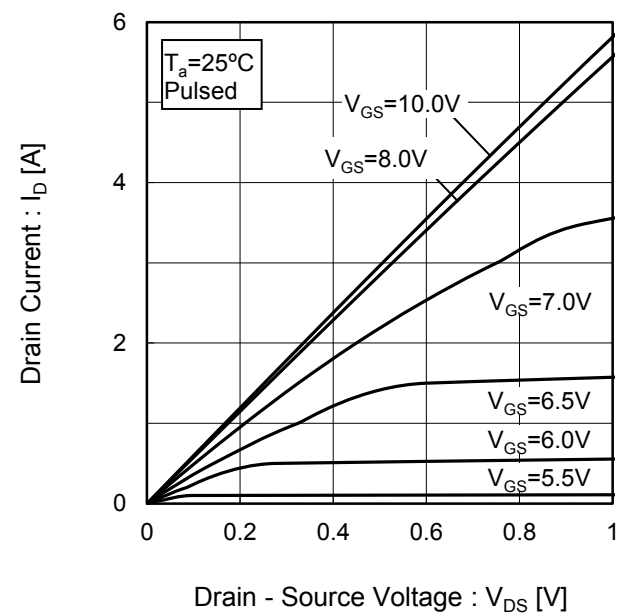
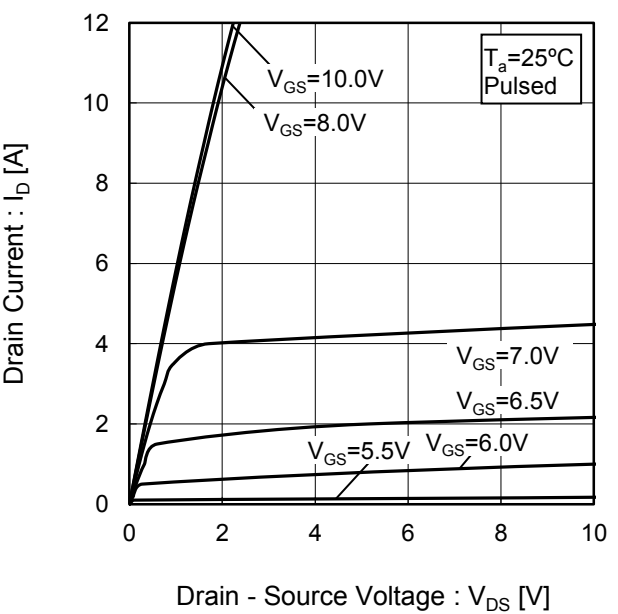


Fig.7 Typical Output Characteristics(II)



●Electrical characteristic curves

Fig.8 Breakdown Voltage  
vs. Junction Temperature

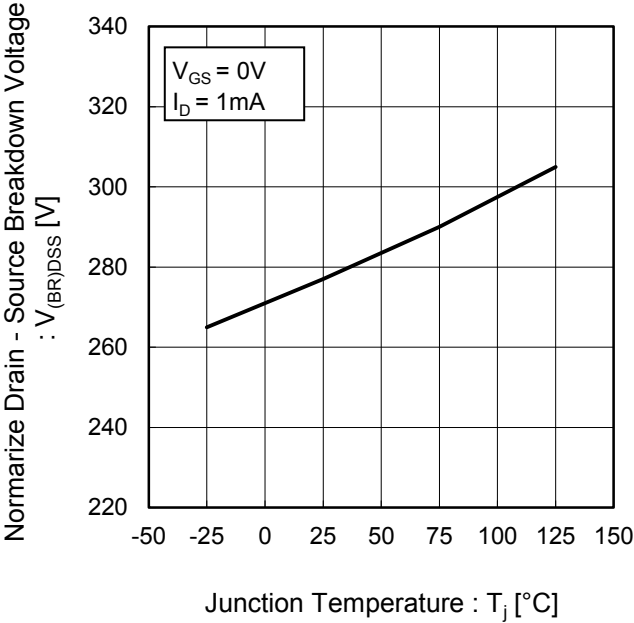


Fig.9 Typical Transfer Characteristics

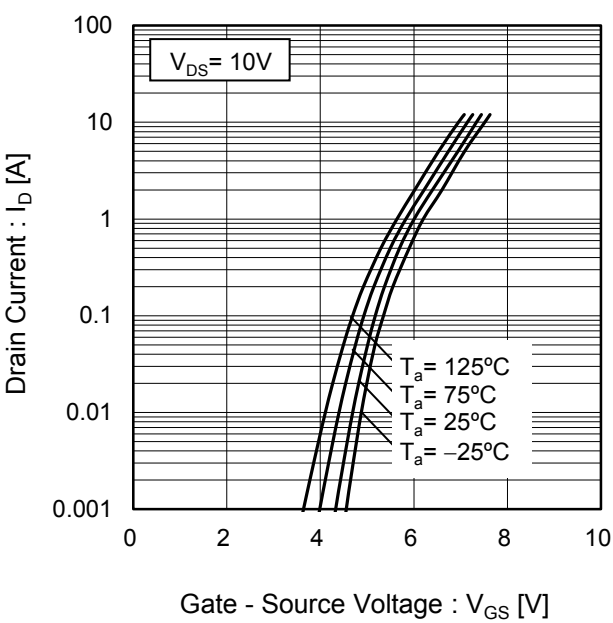


Fig.10 Gate Threshold Voltage  
vs. Junction Temperature

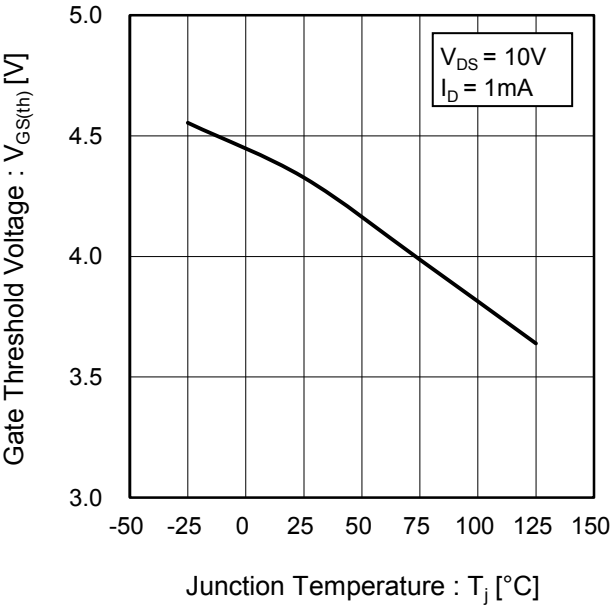
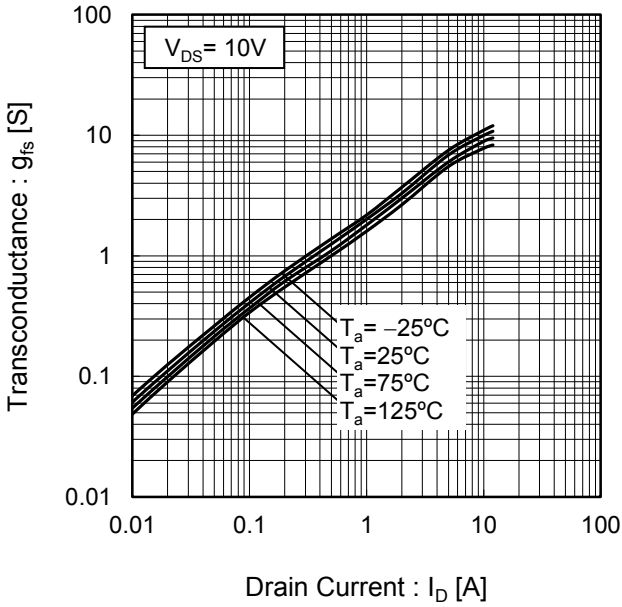


Fig.11 Transconductance vs. Drain Current



●Electrical characteristic curves

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

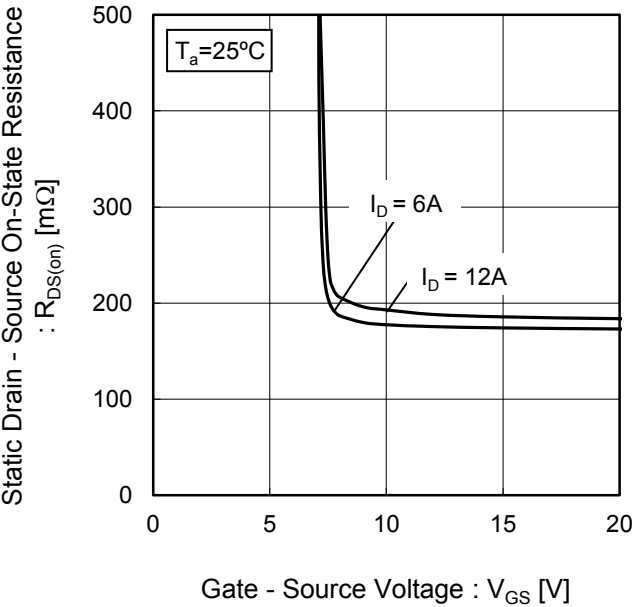


Fig.13 Static Drain - Source On - State Resistance vs. Drain Current( $I$ )

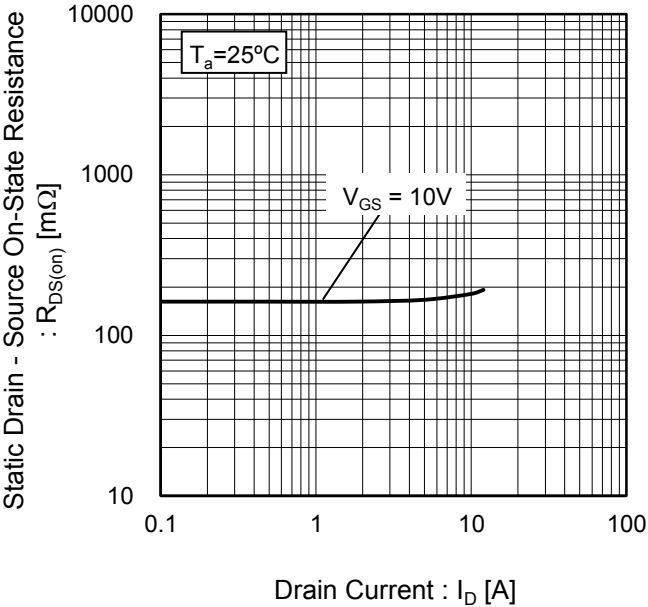
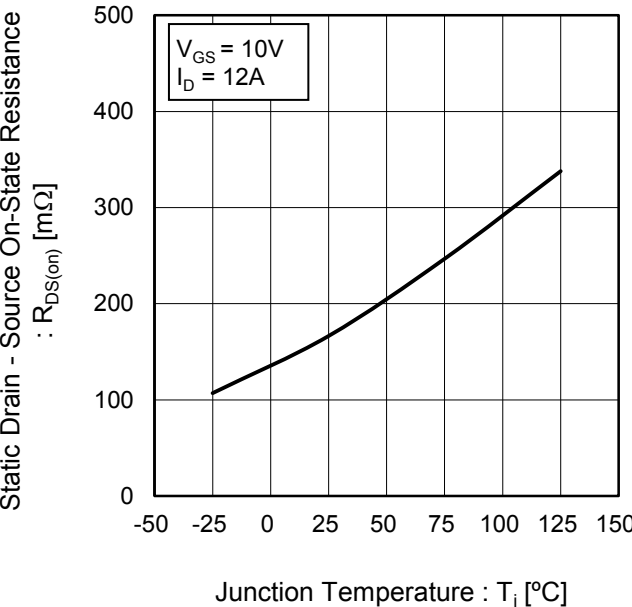


Fig.14 Static Drain - Source On - State Resistance vs. Junction Temperature



●Electrical characteristic curves

Fig.15 Static Drain - Source On - State Resistance vs. Drain Current(I)

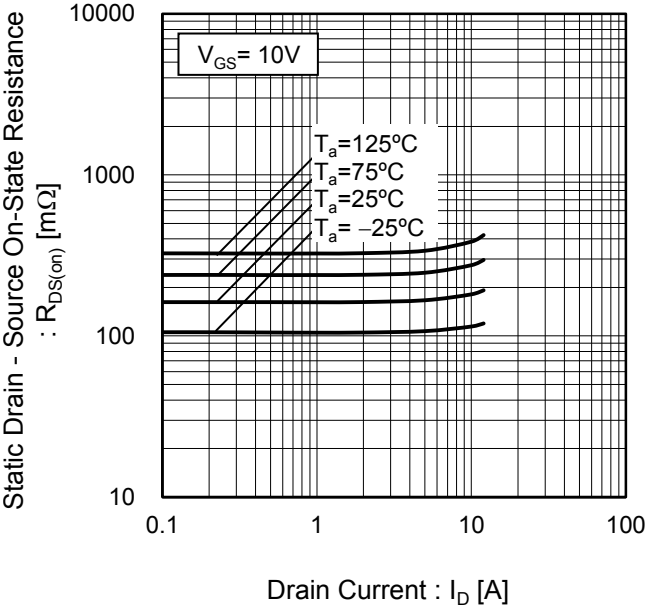
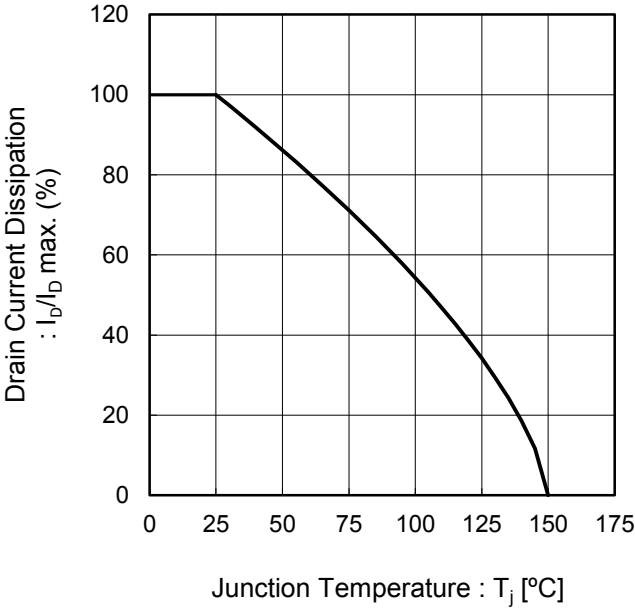


Fig.16 Drain Current Derating Curve





●Electrical characteristic curves

Fig.17 Typical Capacitance vs. Drain - Source Voltage

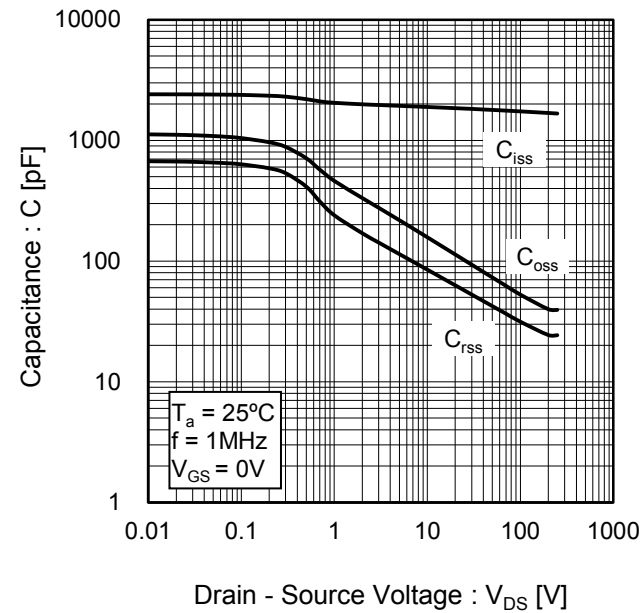


Fig.18 Switching Characteristics

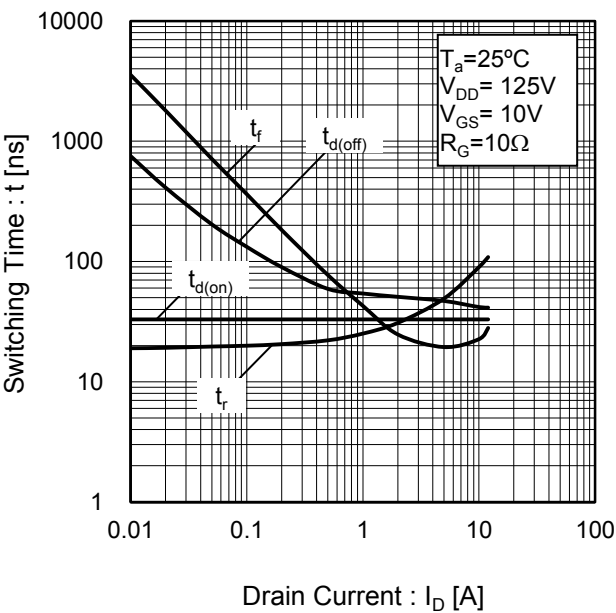
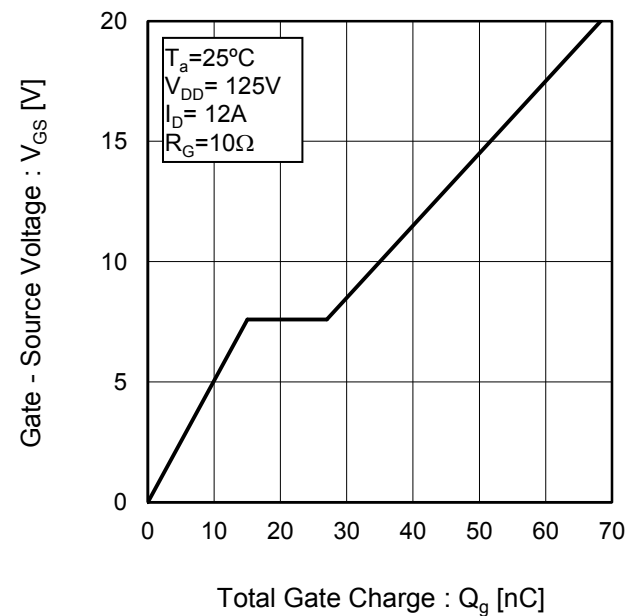


Fig.19 Dynamic Input Characteristics



●Electrical characteristic curves

Fig.20 Source Current  
vs. Source - Drain Voltage

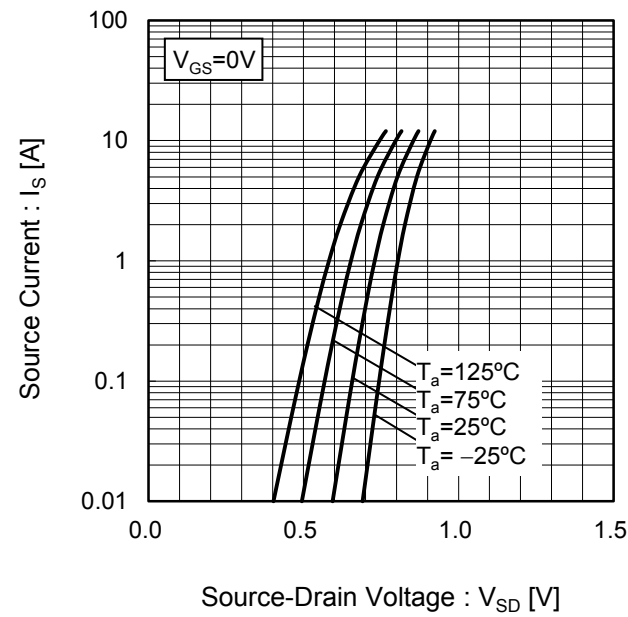
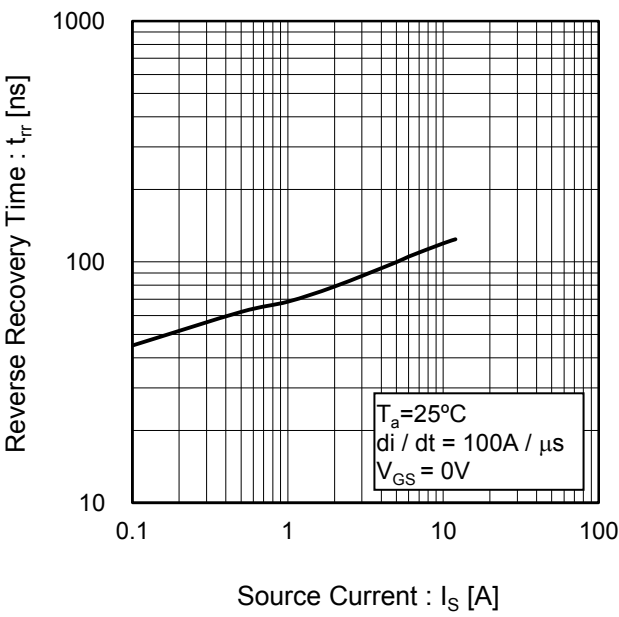


Fig.21 Reverse Recovery Time  
vs. Source Current



●Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

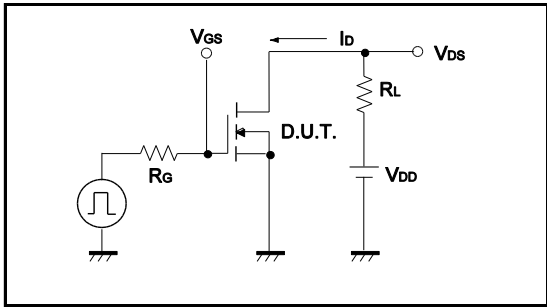


Fig.1-2 Switching Waveforms

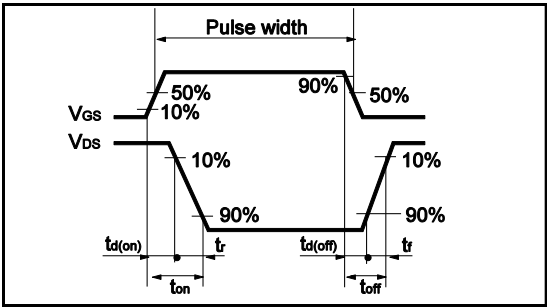


Fig.2-1 Gate Charge Measurement Circuit

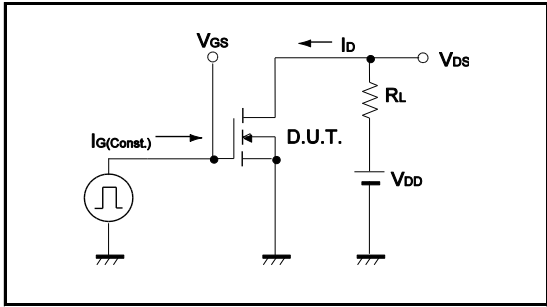


Fig.2-2 Gate Charge Waveform

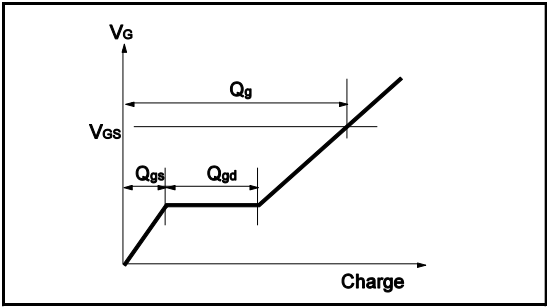


Fig.3-1 Avalanche Measurement Circuit

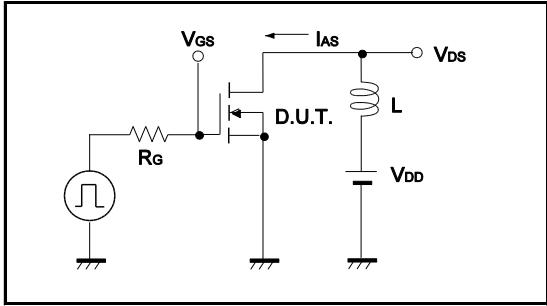
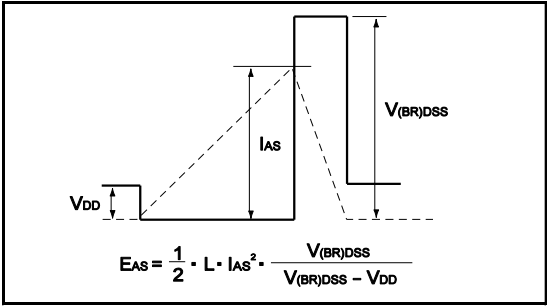
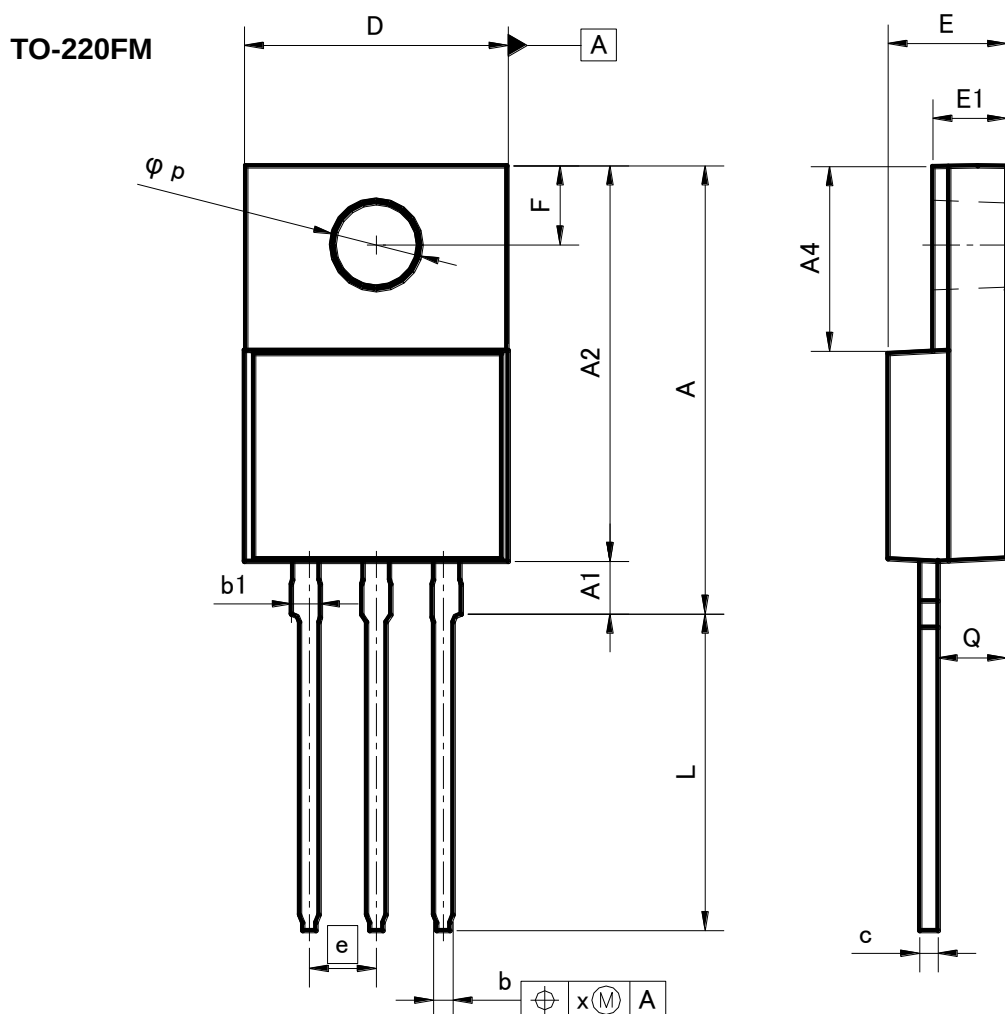


Fig.3-2 Avalanche Waveform



●Dimensions (Unit : mm)



| DIM | MILIMETERS |       | INCHES |       |
|-----|------------|-------|--------|-------|
|     | MIN        | MAX   | MIN    | MAX   |
| A   | 16.60      | 17.60 | 0.654  | 0.693 |
| A1  | 1.80       | 2.20  | 0.071  | 0.087 |
| A2  | 14.80      | 15.40 | 0.583  | 0.606 |
| A4  | 6.80       | 7.20  | 0.268  | 0.283 |
| b   | 0.70       | 0.85  | 0.028  | 0.033 |
| b1  | 1.10       | 1.50  | 0.043  | 0.059 |
| c   | 0.70       | 0.85  | 0.028  | 0.033 |
| D   | 9.90       | 10.30 | 0.39   | 0.406 |
| E   | 4.40       | 4.80  | 0.173  | 0.189 |
| e   | 2.54       |       | 0.10   |       |
| E1  | 2.70       | 3.00  | 0.106  | 0.118 |
| F   | 2.80       | 3.20  | 0.11   | 0.126 |
| L   | 11.50      | 12.50 | 0.453  | 0.492 |
| p   | 3.00       | 3.40  | 0.118  | 0.134 |
| Q   | 2.10       | 3.10  | 0.083  | 0.122 |
| x   | —          | 0.381 | —      | 0.015 |

Dimension in mm/inches

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## RCX120N25 - Web Page

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|                             |           |
|-----------------------------|-----------|
| Part Number                 | RCX120N25 |
| Package                     | TO-220FM  |
| Unit Quantity               | 500       |
| Minimum Package Quantity    | 500       |
| Packing Type                | Bulk      |
| Constitution Materials List | inquiry   |
| RoHS                        | Yes       |